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Kind regards,

Team Nexperia

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω

Rev. 6 — 29 November 2011

Product data sheet

1. Product profile

1.1 General description

NPN/NPN Resistor-Equipped Transistors (RET) in Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

Type number					Package
	NXP	JEITA	complement	complement	configuration
PEMH11	SOT666	-	PEMD3	PEMB11	ultra small and flat lead
PUMH11	SOT363	SC-88	PUMD3	PUMB11	very small

1.2 Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design

1.3 Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per transis	stor					
V _{CEO}	collector-emitter voltage	open base	-	-	50	V
lo	output current		-	-	100	mA
R1	bias resistor 1 (input)		7	10	13	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	



- Reduces component count
- Reduces pick and place costs
- AEC-Q101 qualified

3

| 2 sym063

1

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω

Pinning information 2.

Table 3.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	GND (emitter) TR1		
2	input (base) TR1	6 5 4	
3	output (collector) TR2		
4	GND (emitter) TR2		
5	input (base) TR2		
6	output (collector) TR1	001aab555	

Ordering information 3.

Table 4. Ordering information					
Type number					
	Name	Description	Version		
PEMH11	-	plastic surface-mounted package; 6 leads	SOT666		
PUMH11	SC-88	plastic surface-mounted package; 6 leads	SOT363		

Marking 4.

Table 5. Marking codes	
Type number	Marking code ^[1]
PEMH11	H1
PUMH11	H*1

[1] * = placeholder for manufacturing site code.

5. Limiting values

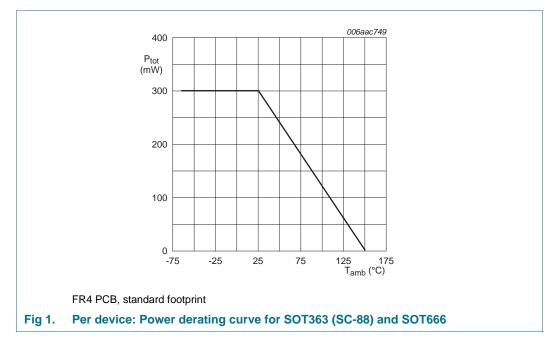
Table 6. In accordar	Limiting values ace with the Absolute Maximu	ım Rating System (IE	C 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor				
V _{CBO}	collector-base voltage	open emitter	-	50	V
V _{CEO}	collector-emitter voltage	open base	-	50	V
V _{EBO}	emitter-base voltage	open collector	-	10	V
VI	input voltage				
	positive		-	+40	V
	negative		-	-10	V
lo	output current		-	100	mA
I _{CM}	peak collector current		-	100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u>		
	PEMH11 (SOT666)		[2] _	200	mW
	PUMH11 (SOT363)		-	200	mW
Per device)				
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1]		
	PEMH11 (SOT666)		[2] _	300	mW
	PUMH11 (SOT363)		-	300	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

PEMH11_PUMH11
Product data sheet

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω



6. Thermal characteristics

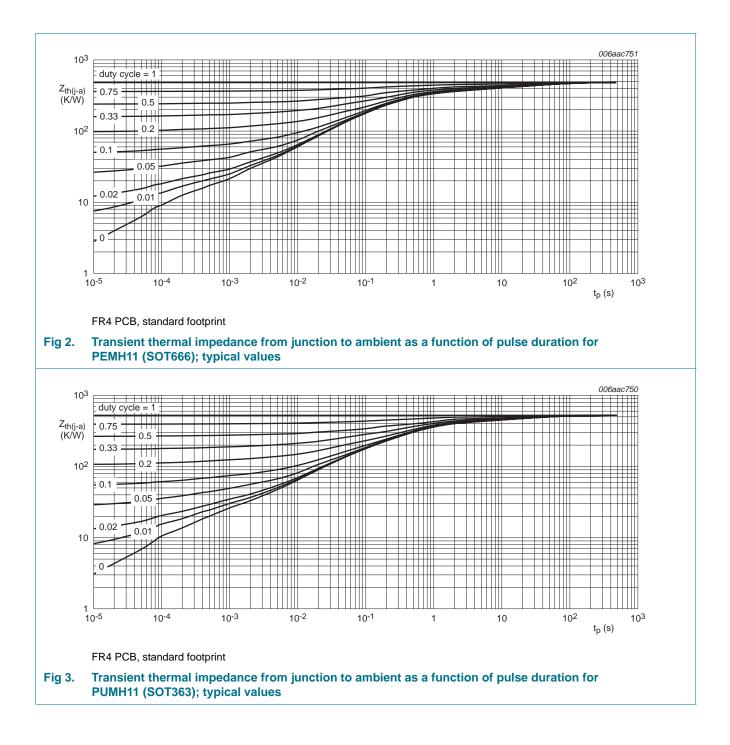
Table 7.	Thermal characteristic	S				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	PEMH11 (SOT666)		[2] _	-	625	K/W
	PUMH11 (SOT363)		-	-	625	K/W
Per devic	e					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	PEMH11 (SOT666)		[2] _	-	417	K/W
	PUMH11 (SOT363)		-	-	417	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

PEMH11; PUMH11

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω



7. Characteristics

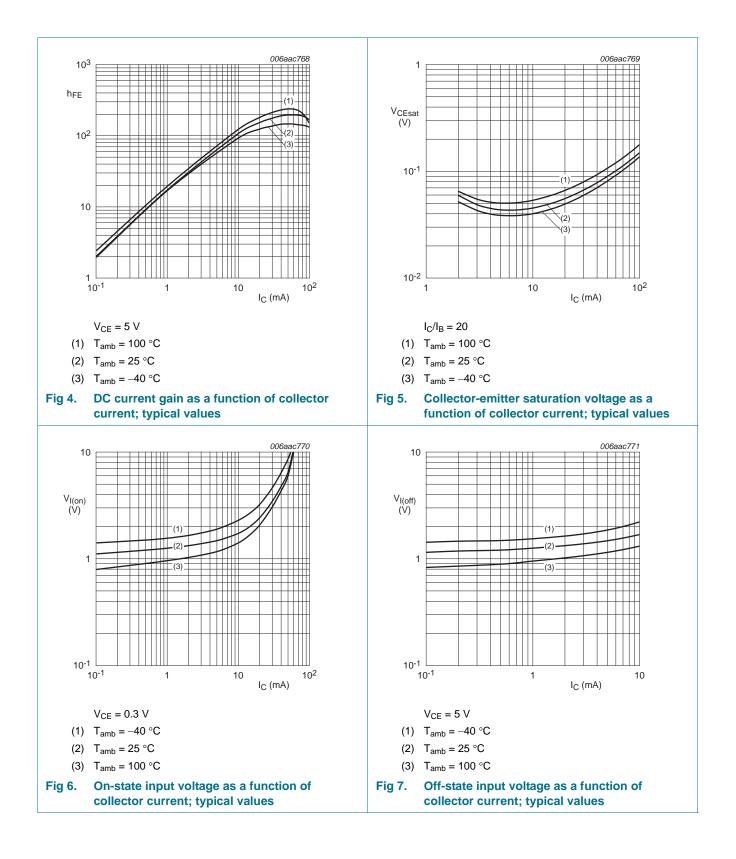
Symbol	Parameter	Conditions	М	in ⁻	Гур	Max	Unit
Per trans	istor						
I _{CBO}	collector-base cut-off current	$V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$	-	-		100	nA
I _{CEO}	CEO collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$	-	-		1	μΑ
		$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A};$ $T_j = 150 \text{ °C}$	-	-	•	5	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 V; I_C = 0 A$	-	-	•	400	μA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$	30) -		-	
V _{CEsat}	collector-emitter saturation voltage	I_{C} = 10 mA; I_{B} = 0.5 mA	-	-	•	150	mV
V _{I(off)}	off-state input voltage	$V_{CE}=5~V;~I_C=100~\mu A$	-		1.1	0.8	V
V _{I(on)}	on-state input voltage	V_{CE} = 0.3 V; I _C = 10 mA	2.	5 <i>´</i>	1.8	-	V
R1	bias resistor 1 (input)		7		10	13	kΩ
R2/R1	bias resistor ratio		0.	8 ′	1	1.2	
C _c	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A}; \\ f = 1 \text{ MHz} \end{array}$	-	-	•	2.5	pF
f _T	transition frequency	V _{CB} = 5 V; I _C = 10 mA; f = 100 MHz	<u>[1]</u> -	2	230	-	MHz

[1] Characteristics of built-in transistor.

PEMH11_PUMH11 Product data sheet

PEMH11; PUMH11

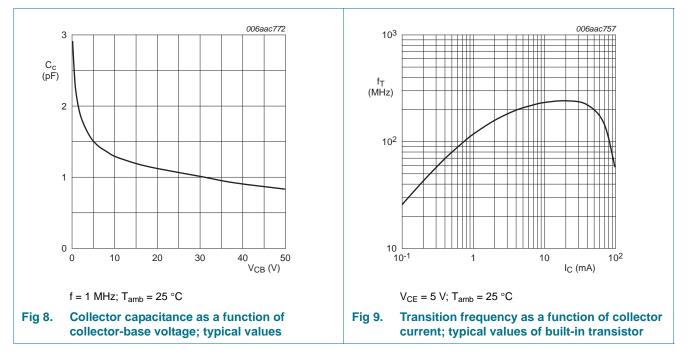
NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω



PEMH11_PUMH11

PEMH11; PUMH11

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω

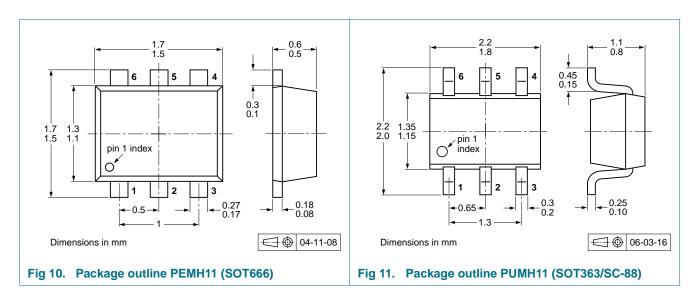


8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω

10. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

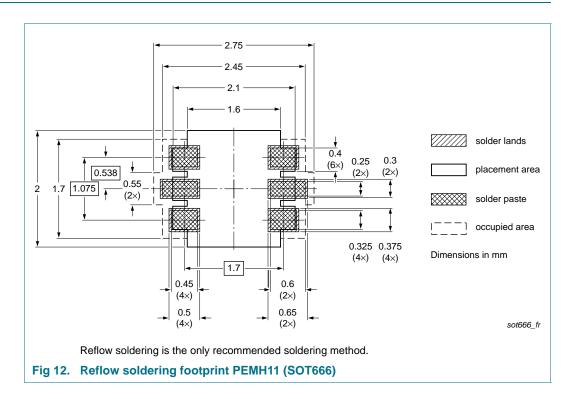
Type number Package		Description		Packing quantity			
			:	3000	4000	8000	10000
PEMH11	SOT666	2 mm pitch, 8 mm tape and reel	-	-	-	-315	-
		4 mm pitch, 8 mm tape and reel	-	-	-115	-	-
PUMH11	SOT363	4 mm pitch, 8 mm tape and reel; T1	[2]	-115	-	-	-135
		4 mm pitch, 8 mm tape and reel; T2	[3]	-125	-	-	-165

[1] For further information and the availability of packing methods, see Section 14.

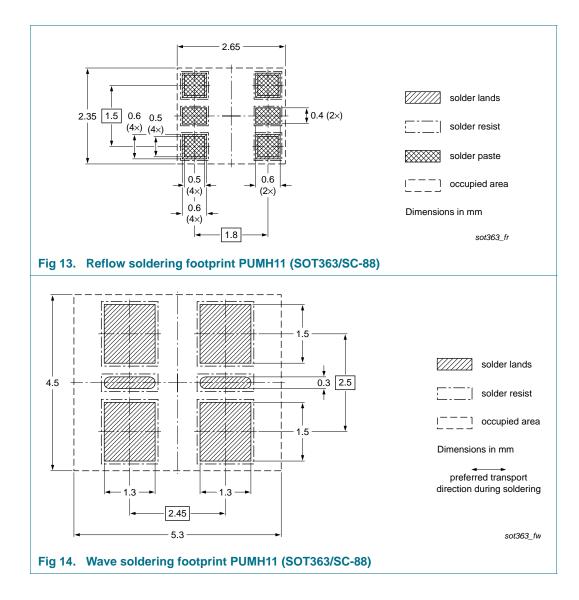
[2] T1: normal taping

[3] T2: reverse taping

11. Soldering



NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω



PEMH11_PUMH11
Product data sheet

12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
PEMH11_PUMH11 v.6	20111129	Product data sheet	-	PEMH11_PUMH11 v.5			
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 						
	 Legal texts have been adapted to the new company name where appropriate. 						
	 <u>Section 1 "Product profile"</u>: updated 						
	 <u>Section 4 "Marking"</u>: updated 						
	 <u>Table 7 "Thermal characteristics"</u>: updated according to the latest measurements 						
	 <u>Table 8 "Characteristics"</u>: I_{CEO} updated according to the latest measurements, V_{i(on)} and V_{i(off)} changed respectively to V_{I(on)} and V_{I(off)}, f_T added 						
	• Figure 1 to 9	: added					
	Section 8 "Test information": added						
	 Figure 10 and 11: replaced by minimized package outline drawings 						
	Section 10 "Packing information": added						
	Section 11 "Soldering": added						
	 Section 13 " 	Legal information": updated	Ł				
PEMH11_PUMH11 v.5	20031020	Product data sheet	-	PUMH11 v.4 PEMH11 v.1			
PUMH11 v.4	19990413	Product specification	-	-			
PEMH11 v.1	20011022	Preliminary specification	-	-			

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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PEMH11_PUMH11

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NPN/NPN resistor-equipped transistors; $R1 = 10 \text{ k}\Omega$, $R2 = 10 \text{ k}\Omega$

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PEMH11; PUMH11

NPN/NPN resistor-equipped transistors; R1 = 10 k Ω , R2 = 10 k Ω

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Date of release: 29 November 2011 Document identifier: PEMH11_PUMH11

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